WDFN8 3.3x3.3, 0.65P
CASE 511DQ
ISSUE 0

DATE 31 OCT 2016

NOTES:
A. PACKAGE DOES NOT FULLY CONFORM TO
   JEDEC REGISTRATION MO-240.
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS AND TOLERANCES PER
D. LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY
   LAND PATTERN
E. DIMENSIONS DO NOT INCLUDE BURRS OR MOLD FLASH.
   BURRS OR MOLD FLASH SHALL NOT EXCEED 0.10MM.

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